

Vishay Siliconix

P-Channel 30-V (D-S) MOSFET

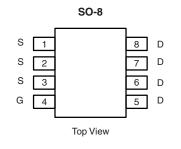
| PRODUCT SUMMARY | | | | | |
|---------------------|--------------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^d | Q _g (Typ.) | | |
| - 30 | 0.005 at V _{GS} = - 10 V | - 29 | 61 nC | | |
| - 30 | 0.00775 at V _{GS} = - 4.5 V | - 23 | 01110 | | |

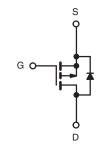
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_a and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Adaptor Switch
- Notebook





P-Channel MOSFET

Ordering Information: Si4459ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted) Parameter Symbol Limit Unit **Drain-Source Voltage** V_{DS} - 30 ٧ Gate-Source Voltage V_{GS} ± 20 $T_{C} = 25 \ ^{\circ}C$ - 29 T_C = 70 °C - 23.5 Continuous Drain Current (T_J = 150 °C) I_D $T_A = 25 \overline{^{\circ}C}$ - 19.7^{a, b} T_A = 70 °C - 15.6^{a, b} А - 70 I_{DM} Pulsed Drain Current T_C = 25 °C - 6.5 Continuous Source-Drain Diode Current ls T_A = 25 °C - 2.9^{a, b} Avalanche Current I_{AS} - 30 L = 0.1 mHSingle-Pulse Avalanche Energy E_{AS} 45 mJ T_C = 25 °C 7.8 T_C = 70 °C 5 P_D Maximum Power Dissipation w T_A = 25 °C 3.5^{a, b} T_A = 70 °C 2.2^{a, b} Operating Junction and Storage Temperature Range T_J, T_{stq} - 55 to 150 °C

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 29 | 35 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 13 | 16 | 0/11 | |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under steady state conditions is 80 °C/W.

d. Based on $T_C = 25$ °C.

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b. t = 10 s.

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|--|------|---------|---------|-------|--|
| Static | | | | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | l _D = - 250 μA | | - 31 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | 5 . | | 5.3 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = - 250 μA | | | - 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | | |
| | | V _{DS} = - 30 V, V _{GS} = 0 V | | | - 100 | nA | |
| Zava Cata Valtaga Drain Current | 1 | $V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 75 | | |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 75 °C | | | - 10 | | |
| | | V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 75 °C | | | - 3 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| | | V _{GS} = - 10 V, I _D = - 15 A | | 0.0039 | 0.005 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 10 A | | 0.0062 | 0.00775 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 15 A | | 24 | | S | |
| Dynamic ^b | | | | • | | | |
| Input Capacitance | C _{iss} | | | 6000 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 860 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 790 | | | |
| Total Gate Charge | 0 | $V_{D0} = -15 V_{10} V_{00} = -10 V_{10} I_{0} = -20 A$ | | 129 | 195 | nC | |
| | Q_g | | | 61 | 95 | | |
| Gate-Source Charge | Q_gs | V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 20 A | | 16.5 | | | |
| Gate-Drain Charge | Q _{gd} | | | 23.5 | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.6 | 3 | 6 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 16 | 30 | - | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 1.5 Ω | | 16 | 30 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 80 | 150 | | |
| Fall Time | t _f | | | 20 | 40 | | |
| Turn-On Delay Time | t _{d(on)} | | | 75 | 150 | ns | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 1.5 Ω | | 130 | 260 | - | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 60 | 120 | | |
| Fall Time | t _f | , i i i i i i i i i i i i i i i i i i i | | 40 | 80 | | |
| Drain-Source Body Diode Characteris | stics | | | | | | |
| Continous Source-Drain Diode Current | ۱ _s | T _C = 25 °C | | | - 29 | | |
| Pulse Diode Forward Current | I _{SM} | - | | | - 70 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A, V _{GS} = 0 V | | - 0.71 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 67 | 130 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | I _F = - 5 A, dl/dt = 100 A/μs, T _J = 25 °C | | 74 | 150 | nC | |
| Reverse Recovery Fall Time | ta | | | 22 | | | |
| Reverse Recovery Rise Time | t _b | | | 45 | | ns | |

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

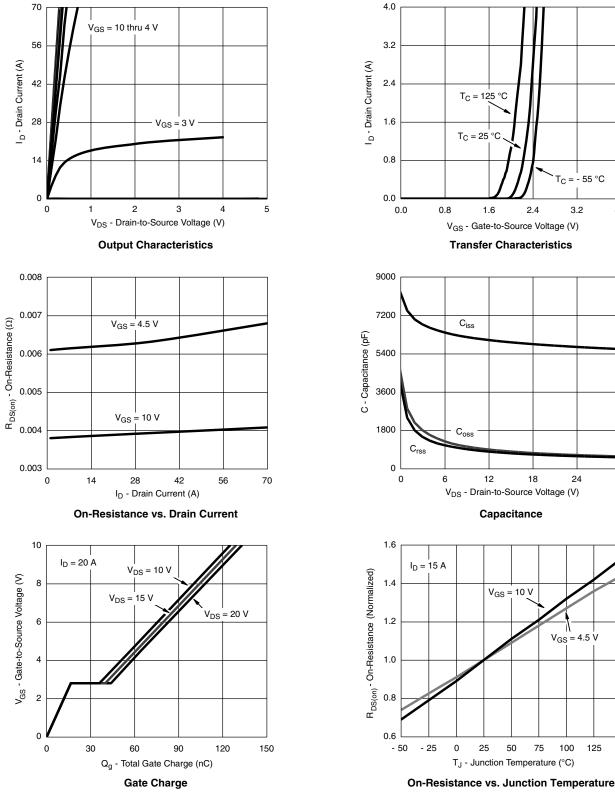
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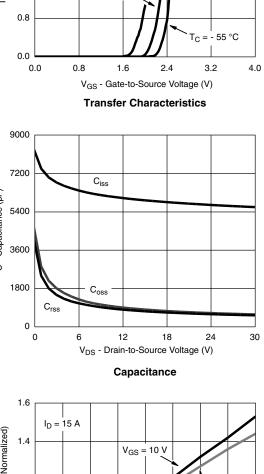
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Si4459ADY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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 $V_{GS} = 4.5 V$

125 150

50

75

100

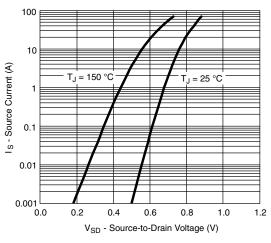
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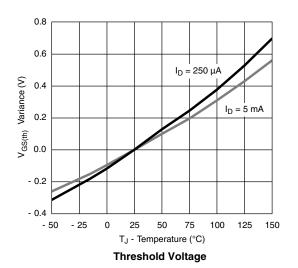


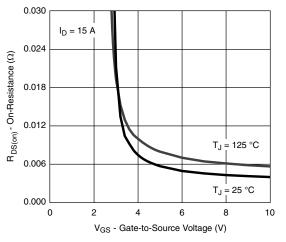


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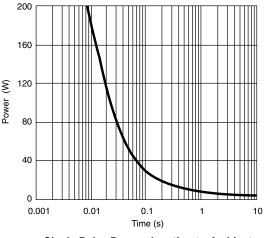


Source-Drain Diode Forward Voltage

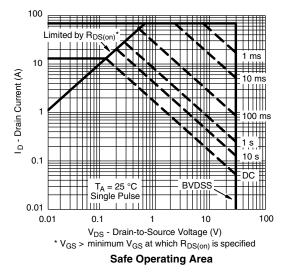




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

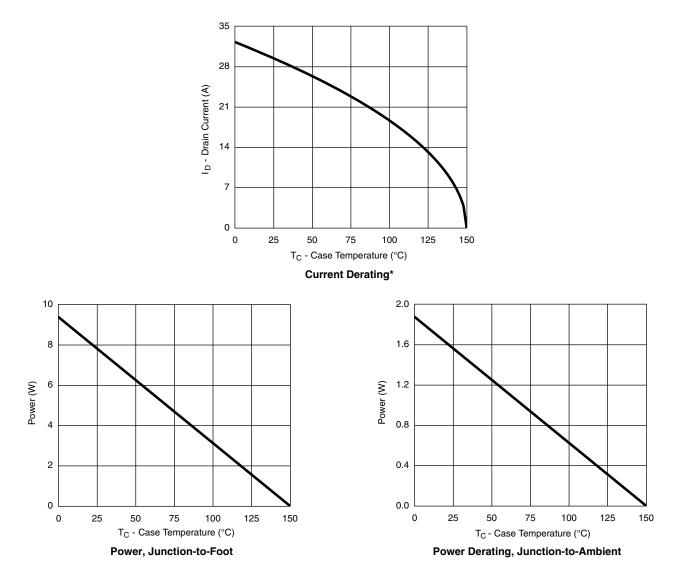


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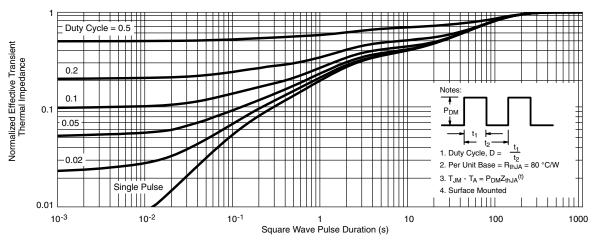
* The power dissipation P_D is based on T_{J(max)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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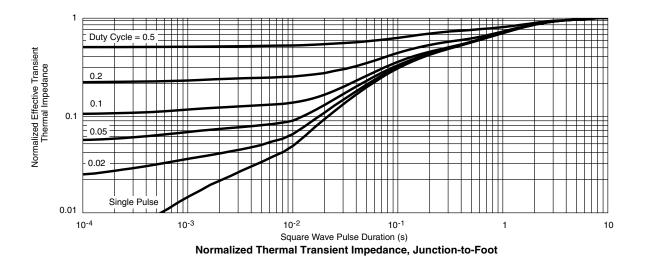


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg269979.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





| | MILLIM | IETERS | INC | HES | |
|---|----------|--------|-----------|-------|--|
| DIM | Min | Мах | Min | Max | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 BSC | | 0.050 BSC | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | |

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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